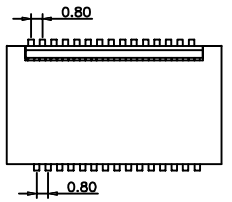
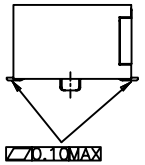
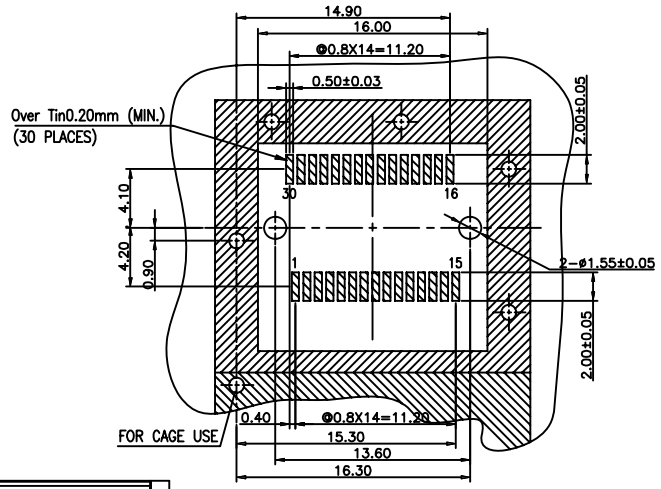
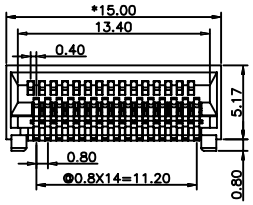
REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD

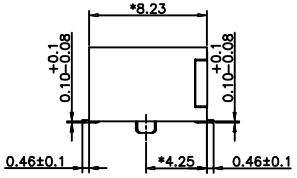


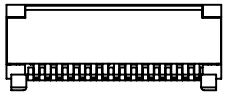


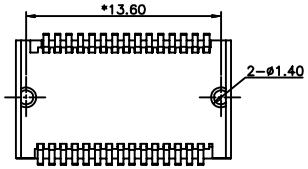


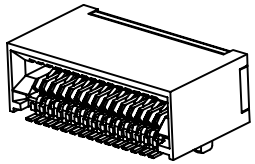
PCB LAYOUT (CONNECTOR) / TOP VIEW











NOTE:
MECHANICAL:
CONNECTOR MATERIAL:
1. HOUSING:HIGHT TEMPERATURE THERMOPLASTIC GLASS FIELD. UL94V-0.
:STANDARD COLOR :BLACK.
2.CONTACT: PHOS-BRONZE THICKNESS=0.20mm.
3.DURABILITY:250 CYCLES MIN.

ELECTRICAL:
1.VOLTAGE RATING : 30 VAC RMS MAX.
2.CURRENT RATING : 0.5 AMP MAX.
3.DIFFERENTIAL IMPEDANCE : 100 Ohms.
4.CAPACITANCE:1.2pF MAX.
5.CONTACT RESISTANCE: 20 MILLIOHMS MAX.
6.INSULATION RESISTANCE: 500 MEGAOHMS MIN.
7.TEMPERATURE:
OPERATING:-55°C to +85°C
STORAGE:-55°C to +85°C
IR REFLOW SOLDER TEMPERTURE SUGGEST 250°C~270°C.

PART NUMBER : XFP-002X-L
GOLD PLATED:
1- 3u" 2- 6u" 3-15u"
4-30u" 5-50u"

MM (INCH)	DFTO JERRY	DATE 05/15/07	Xmultiple Technologies Inc.
TOLERANCES EXCEPT AS NOTED	CHKD ANDY	DATE 05/16/07	
MM .0 ±0.20 ± .00 ±0.15 ± .000 ±0.075 ±	MFO	DATE	TITLE: XFP CONNECTOR 30P
	APPVL ALANN	DATE 05/18/07	
ANGLES ±	MATERIAL :		DRAWING NO. XFP-002 /PART NO. SEE NOTE
THIRD ANGLE PROJECTION	QT'Y :		SIZE A3 REV O
DETACHED LISTS	FINISH :		DO NOT SCALE DRAWING SHEET X OF Y
	SCALE :		

H G F E D C B A

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